

PC452 Series

Mini-flat Package, Darlinton Phototransistor Output, High Collector-emitter Voltage Photocoupler



■ Description

PC452 Series contains an IRED optically coupled to a phototransistor.

It is packaged in a 4-pin Mini-flat. Input-output isolation voltage(rms) is 3.75kV. Collector-emitter voltage is 350V and CTR is MIN.

1 000% at input current of 1.0mA.

■ Features

- 1. 4-pin Mini-flat package
- Double transfer mold package (Ideal for Flow Soldering)
- 3. High collector-emitter voltage (V_{CEO}: 350V)
- 4. Darlington phototransistor output (CTR : MIN. 1 000% at I_F=1mA, V_{CE}=2V)
- 5. High isolation voltage between input and output $(V_{iso(rms)}: 3.75kV)$

■ Agency approvals/Compliance

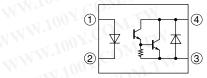
- 1. Recognized by UL1577 (Double protection isolation) file No. E64380 (as model No. **PC452**)
- 2. Package resin: UL flammability grade (94V-0)

■ Applications

- 1. Telephone sets
- 2. Copiers, facsimiles
- Interfaces with various power supply circuits, power distribution boards
- Hybrid substrates which reguire high density mounting



■ Internal Connection Diagram



- Jainode

 ③ Emitter

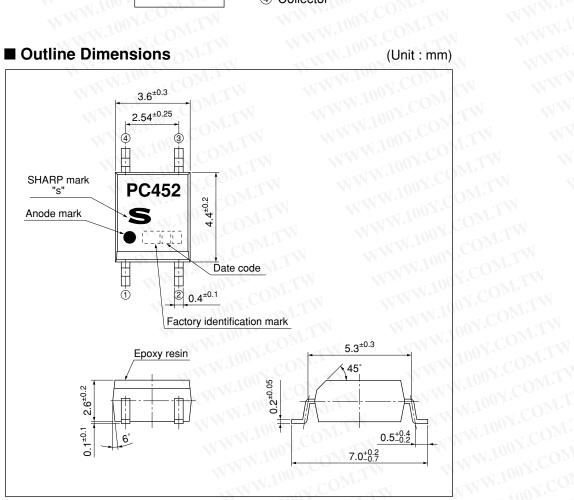
 ④ Co"

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- 4 Collector WWW.100Y.COM.TW

■ Outline Dimensions

(Unit: mm)



Product mass : approx. 0.1g

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Date code (2 digit)

	1st o	digit	«A	2nd d	igit
Year of production			Month of production		
A.D.	Mark	A.D	Mark	Month	Mark
1990	A	2002	P	January	I.Co. 1 TW
1991	В	2003	R	February	V.CO 2
1992	C	2004	S	March	3
1993	D	2005	T	April	4.1.1
1994	Е	2006	U	May	00 Y . 5
1995	F	2007	V	June	60
1996	Н	2008	\sim W	July	7c0M-
1997	J	2009	X	August	N.100 8 OM.
1998	K	2010	Α	September	1009
1999	L	2011	В	October	OV.COM
2000	M	2012	CO	November	N CO
2001	N	-ix11	$p_{0,i}$: \sim	December	D

Factory identification mark

Factory identification Mark	Country of origin
no mark	Japan
4	Indonesia
$\overline{}$	Philippines
•	China

^{*} This factory marking is for identification purpose only. Please Contact the local SHARP sales reprsentative to see the actual status of the production.

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Parameter	Symbol	Rating	Unit
Forward current	I_{F}	50	mA
Reverse voltage	V_R	6	V
Power dissipation	P	70	mW
Collector-emitter voltage	V_{CEO}	350	V
Emitter-collector voltage Collector current	V_{ECO}	0.1	V
Collector current	$I_{\mathbf{C}}$	150	mA
Collector power dissipation	P_{C}	150	mW
Total power dissipation	P _{tot}	170	mW
Operating temperature	T_{opr}	-30 to +100	°C
Storage temperature	T_{stg}	-40 to +125	°C
*1 Isolation voltage	$V_{iso\ (rms)}$	3.75	kV
*2 Soldering temperature	T_{sol}	260	°C -

^{*1 40} to 60%RH, AC for 1 minute, f=60Hz

.100Y.COM.TW **■** Electro-optical Characteristics

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	Parameter	MM	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	Forward volta	age	$V_{\rm F}$	I _F =10mA	1.00	1.2	1.4	V
Input	Reverse Curre	ent	I_R	$V_R=4V$	A.COM	T.	10	μΑ
	Terminal capa	acitance	C_t	V=0, f=1kHz	7.00	30	250	pF
)44	Collector darl	k current	I _{CEO}	$V_{CE}=200V, I_{F}=0$	001.	W.7_/	200	nA
Output	Collector-emitter brea	akdown voltage	BV _{CEO}	I_{C} =0.1mA, I_{F} =0	350	WEI	- 1	V
	Collector curr	rent	$I_{\rm C}$	$I_F=1$ mA, $V_{CE}=2$ V	10	- W.	_	mA
	Collector-emitter sat	uration voltage	V _{CE (sat)}	I _F =20mA, I _C =100mA	100	OV	1.2	V
ransfer	Isolation resis	stance	R _{ISO}	DC500V, 40 to 60%RH	5×10 ¹⁰	1×10 ¹¹	_	Ω
narac-	Floating capa	citance	C_{f}	V=0, f=1MHz	-n01/	0.6	1.0	pF
ristics	Cut-off freque	ency	$f_{\mathbf{C}}$	$V_{CE}=2V, I_{C}=20mA, R_{L}=100\Omega, -3dB$	1	C 7	-W-	kHz
	D .:	Rise time	t _r	V 2V I 20 A B 1000	MILION	100	300	μs
	Response time	Fall time	$t_{\rm f}$	V_{CE} =2V, I_C =20mA, R_L =100 Ω	- 10 × 10	20	100	μs

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^{*2} For 10s



■ Model Line-up

Doolsoo	Тар	ing
Package	3 000 pcs/reel	750 pcs/reel
Model No.	PC452	PC452T

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Please contact a local SHARP sales representative to inquire about production status and Lead-Free options.



Fig.1 Forward Current vs. Ambient **Temperature**

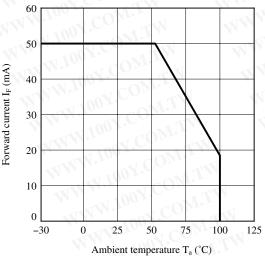


Fig.2 Collector Power Dissipation vs. **Ambient Temperature**

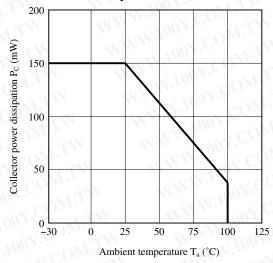


Fig.3 Peak Forward Current vs. Duty Ratio

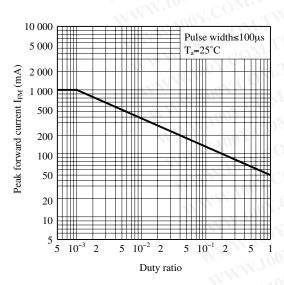


Fig.5 Current Transfer Ratio vs. Forward Current

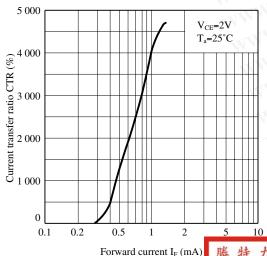


Fig.4 Forward Current vs. Forward Voltage

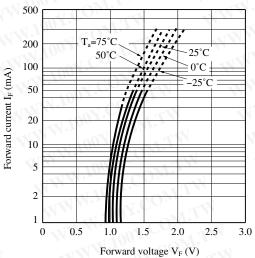
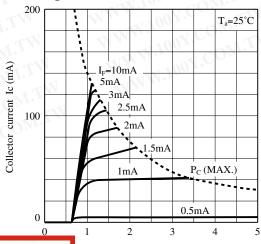


Fig.6 Collector Current vs. Collector-emitter Voltage



Collector-emitter voltage $V_{CE}(V)$

Sheet No.: D2-A00901EN



Fig.7 Relative Current Transfer Ratio vs.
Ambient Temperature

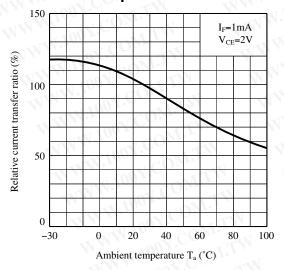


Fig.9 Collector Dark Current vs. Ambient Temperature

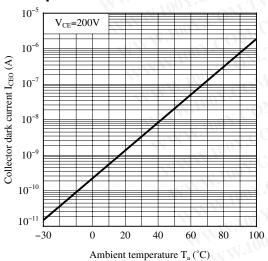
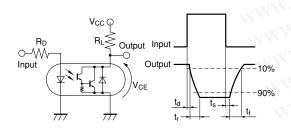


Fig.11 Test Circuit for Response Time



Please refer to the conditions in Fig.10

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Fig.8 Collector - emitter Saturation Voltage vs. Ambient Temperature

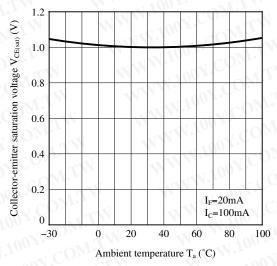


Fig.10 Response Time vs. Load Resistance

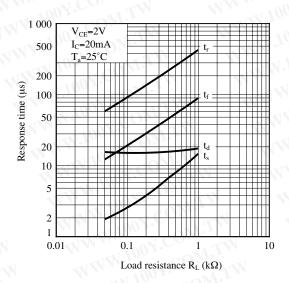
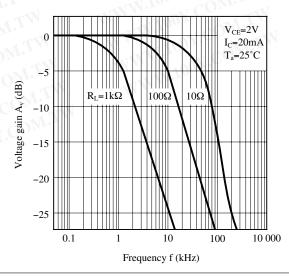


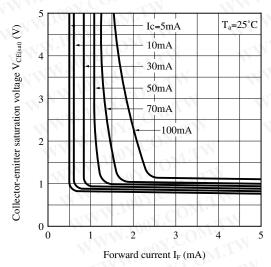
Fig.12 Frequency Response



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Fig.13 Collector-emitter Saturation Voltage vs. Forward Current



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Remarks: Please be aware that all data in the graph are just for reference and not for guarantee.



■ Design Considerations

Design guide

While operating at I_F<1.0mA, CTR variation may increase.

Please make design considering this fact.

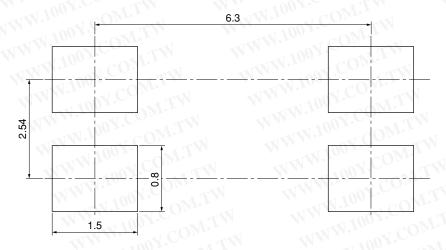
This product is not designed against irradiation and incorporates non-coherent IRED.

Degradation

In general, the emission of the IRED used in photocouplers will degrade over time.

In the case of long term operation, please take the general IRED degradation (50% degradation over 5years) into the design consideration.

Recommended Foot Print (reference)



(Unit: mm)

[☆] For additional design assistance, please review our corresponding Optoelectronic Application Notes.



■ Manufacturing Guidelines

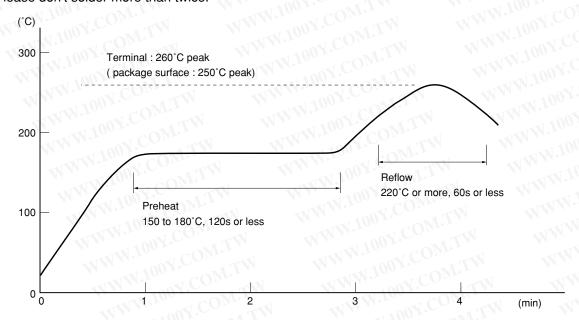
Soldering Method

Reflow Soldering:

Reflow soldering should follow the temperature profile shown below.

Soldering should not exceed the curve of temperature profile and time.

Please don't solder more than twice.



Flow Soldering:

Due to SHARP's double transfer mold construction submersion in flow solder bath is allowed under the below listed guidelines.

Flow soldering should be completed below 260°C and within 10s.

Preheating is within the bounds of 100 to 150°C and 30 to 80s.

Please don't solder more than twice.

Hand soldering

Hand soldering should be completed within 3s when the point of solder iron is below 400°C.

Please don't solder more than twice.

Other notices

Please test the soldering method in actual condition and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the tooling and soldering conditions.



Cleaning instructions

Solvent cleaning:

Solvent temperature should be 45°C or below Immersion time should be 3minutes or less

Ultrasonic cleaning:

The impact on the device varies depending on the size of the cleaning bath, ultrasonic output, cleaning time, size of PCB and mounting method of the device.

Therefore, please make sure the device withstands the ultrasonic cleaning in actual conditions in advance of mass production.

Recommended solvent materials:

Ethyl alcohol, Methyl alcohol and Isopropyl alcohol

In case the other type of solvent materials are intended to be used, please make sure they work fine in actual using conditions since some materials may erode the packaging resin.

Presence of ODC

This product shall not contain the following materials.

And they are not used in the production process for this device.

Regulation substances:CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methylchloroform)

Specific brominated flame retardants such as the PBBOs and PBBs are not used in this product at all.

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■ Package specification

Tape and Reel package

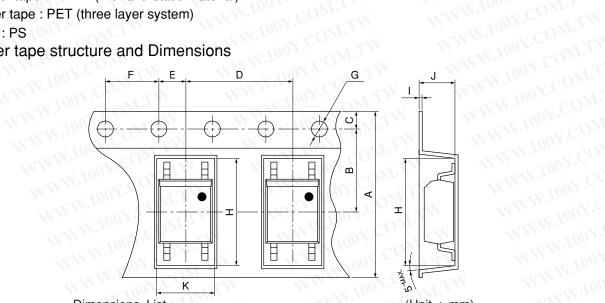
1. 3 000pcs/reel Package materials

Carrier tape: A-PET (with anti-static material)

Cover tape: PET (three layer system)

Reel: PS

Carrier tape structure and Dimensions



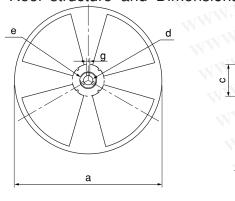
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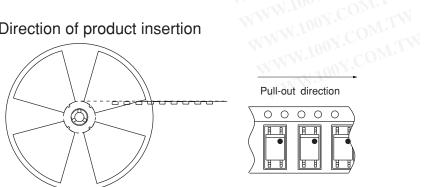
Dimensio	ns List			AN AN AN	1	Jnit : mm)
A	В	O/C	D	E	F	G
12.0±0.3	5.5 ^{±0.1}	1.75 ^{±0.1}	8.0 ^{±0.1}	2.0 ^{±0.1}	$4.0^{\pm0.1}$	φ1.5 + 8.1
Н	I	J	K		T 100Y	·
7.4 ^{±0.1}	0.3±0.05	3.1 ^{±0.1}	4.0 ^{±0.1}	WW	, 00	Co
7.410.1	0.320.03	Y.COM	1.T.N	WY	MN.100	OY.COM
and Dir	mension	00x.CO				

Reel structure and Dimensions



Dimensio	1	MJ > .	nit : mm)
a	b	C C	d
370	13.5 ^{±1.5}	80±1.0	13 ^{±0.5}
e	f	g	TY
21±1.0	$2.0^{\pm0.5}$	2.0±0.5	$\mathbb{C}O_{Mr}$.

Direction of product insertion



[Packing: 3 000pcs/reel]

Sheet No.: D2-A00901EN

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2. 750 pcs / reel Package materials

Carrier tape : A-PET (with anti-static material)

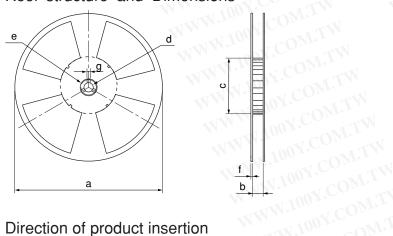
Cover tape : PET (three layer continuation)

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Cover tape : PET (three layer system) Reel : PS	Http://www.100y.com.tw
Carrier tape structure and Dimensions	
F E D G	M JWWW.100Y.COM.TW
	CIN MMM.100X.COM.IX
	N 3 W W 100 Y CON T
	TOM STANKED WANTED
K K	
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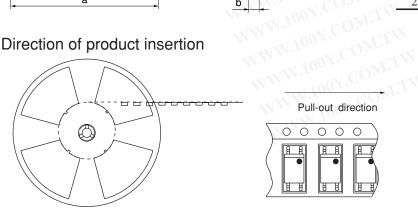
Dimensions	List	MI		TWW.	~<7 CO	(Unit: mm
A	В	C	D	Е	F	G
12.0±0.3	5.5 ^{±0.1}	1.75 ^{±0.1}	8.0 ^{±0.1}	2.0 ^{±0.1}	4.0 ^{±0.1}	φ1.5 + 8.1
Н	I	J. J	K	WWW	. Anny.	U
$7.4^{\pm0.1}$	0.3±0.05	3.1 ^{±0.1}	4.0 ^{±0.1}	TIW!	1.10	CO_{Mr}
MM	M.100	Y.COM	.TW	WW	WW.100	Y.COM
and Dir	mansion	6				

Reel structure and Dimensions



Dimensio	ns List	_ CO (U	nit : mm
a	b100	c	d
180	13.5 ^{±1.5}	80 ^{±1.0}	13±0.5
e	f	g	W
21±1.0	2.0 ^{±0.5}	2.0±0.5)Mr.

Direction of product insertion



[Packing: 750pcs/reel]



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 - --- Office automation equipment
 - --- Telecommunication equipment [terminal]
 - --- Test and measurement equipment
 - --- Industrial control
 - --- Audio visual equipment
 - --- Consumer electronics
- (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection

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- --- Traffic signals
- --- Gas leakage sensor breakers
- --- Alarm equipment
- --- Various safety devices, etc.
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